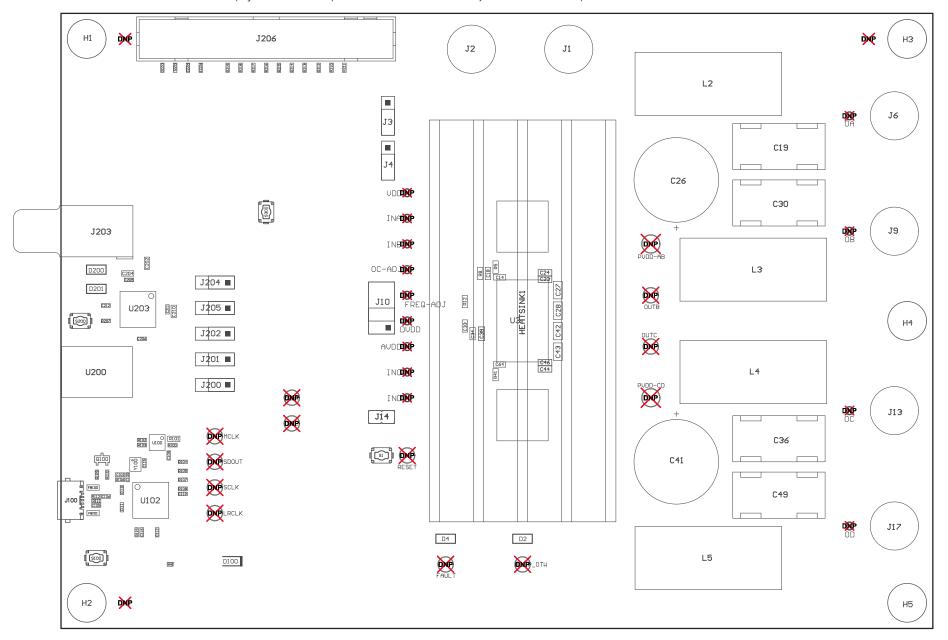
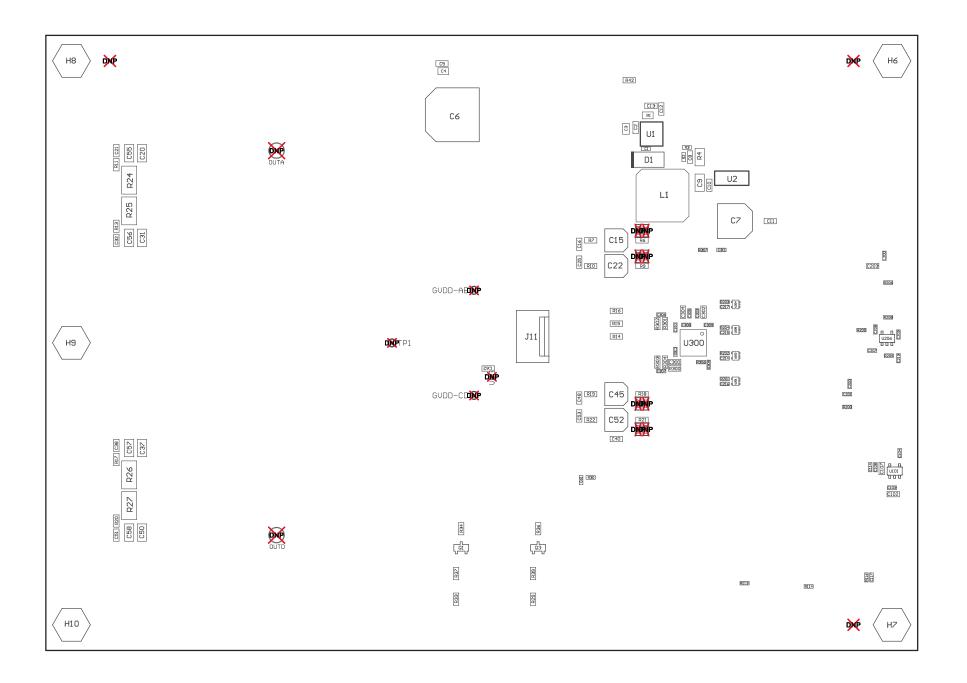
ZZZ These assemblies are ESD sensitive, ESD precautions shall be observed.
ZZ3 These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
ZZI These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00874	REV: E1	SUN REV	: Not In VersionControl			
	TIDA-00874						
PLOT NAME = Top Assembly Drawing	GENERATED : 11/13/	2015 5: 02: 26	PM	TEXAS INSTRUMENTS			



PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00874	REV: E1	SUN REU:	: Not In VersionControl			
TIDA-00874							
PLOT NAME = Bottom Assembly Drawing	GENERATED : 11/13/	2015 5: 02: 28	PM	TEXAS INSTRUMENTS			

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